

General Description

The SIR468DP-T1-GE3 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable to use in

General Features

V_{DS} =30V l_D =60A

 $R_{DS(ON)}$ < 5.8m Ω @ V_{GS} =10V

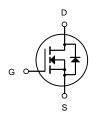
Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

DFN5X6-8L



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
SIR468DP-T1-GE3	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (T_C=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
Vos	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V	ntinuous Drain Current, V _{GS} @ 10V 60	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V 38		А
Івм	Pulsed Drain Current ²	135	А
EAS	Single Pulse Avalanche Energy ³	29.8	mJ
P _D @T _C =25°C	Total Power Dissipation ⁴	30	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range -55 to 150		°C
R _θ JC	Thermal Resistance from Junction-to-Ambient ³ 4.6		°C/W
Reja	Thermal Resistance Junction-Ambient ¹	50	°C/W



Electrical Characteristics (T_J = 25°C, unless otherwise noted)

Symbol	ool Parameter Conditions		Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
R _{DS(ON)}		V _{GS} =10V , I _D =20A		4.4	5.8	mΩ
	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =15A		6.9	9	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.2		2.5	V
IDSS	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25℃			1	uA
		V _{DS} =24V , V _{GS} =0V , T _J =55℃			5	
Igss	Gate-Source Leakage Current	$V_{GS}=\pm20V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		67		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (4.5V)			8		
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		2.4		nC
Q_{gd}	Gate-Drain Charge			3.2		
T _{d(on)}	Turn-On Delay Time			7.1		
Tr	Rise Time	V_{DD} =15 V , V_{GS} =10 V , R_{G} =3.3 Ω		40		ns
T _{d(off)}	Turn-Off Delay Time	I _D =15A		15		
Tf	Fall Time			6		
Ciss	Input Capacitance			814		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		498		pF
Crss	Reverse Transfer Capacitance			41		
Is	Continuous Source Current ^{1,6}	V _G =V _D =0V , Force Current			60	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V
trr	Reverse Recovery Time	IF=20A , di/dt=100A/μs ,		15		nS
Qrr	Reverse Recovery Charge	T _J =25℃		25		nC

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leqq 300 us$, duty cycle $\leqq 2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =24A
- 4. The power dissipation is limited by 150°C junction temperature 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

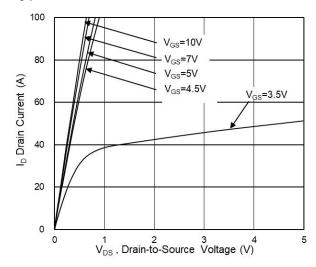


Fig.1 Typical Output Characteristics

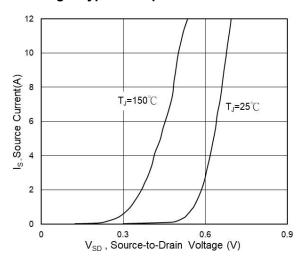


Fig.3 Source Drain Forward Characteristics

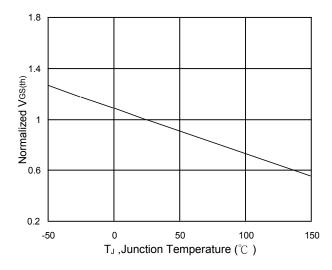


Fig.5 Normalized V_{GS(th)} vs T_J

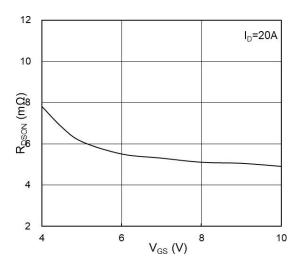


Fig.2 On-Resistance vs G-S Voltage

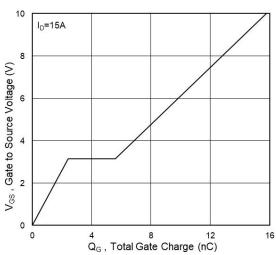


Fig.4 Gate-Charge Characteristics

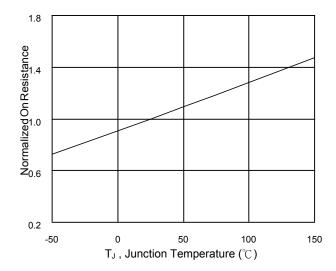
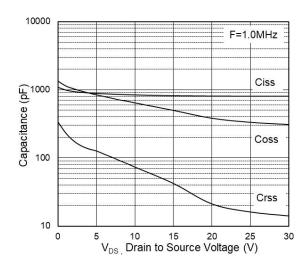


Fig.6 Normalized R_{DSON} vs T_J



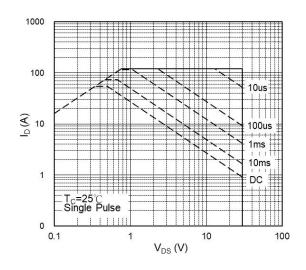


Fig.7 Capacitance

Fig.8 Safe Operating Area

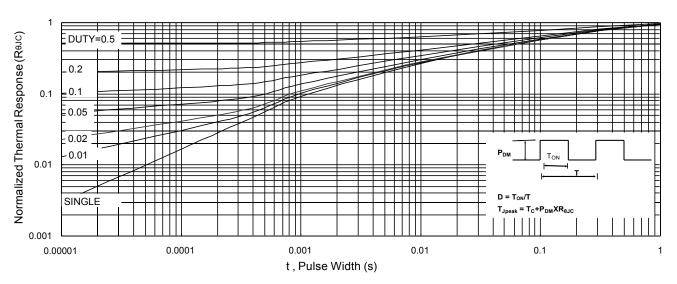


Fig.9 Normalized Maximum Transient Thermal Impedance

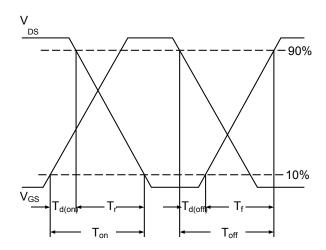


Fig.10 Switching Time Waveform

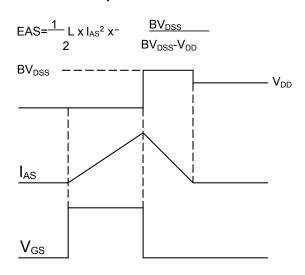
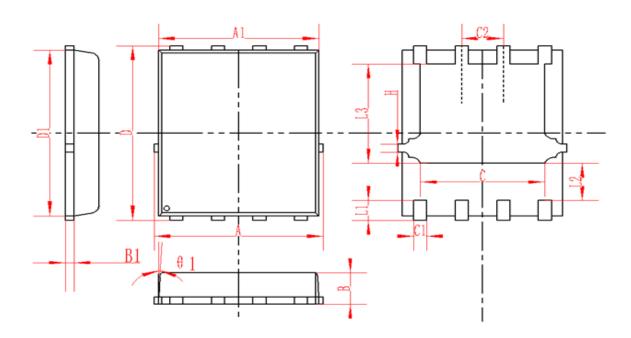


Fig.11 Unclamped Inductive Switching Waveform



DFN5X6-8L Package Information



SYMBOL		MM		INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX	
А	4.95	5	5.05	0.195	0.197	0.199	
A1	4.82	4.9	4.98	0.190	0.193	0.196	
D	5.98	6	6.02	0.235	0.236	0.237	
D1	5.67	5.75	5.83	0.223	0.226	0.230	
В	0.9	0.95	1	0.035	0.037	0.039	
B1	0.254REF		0.010REF				
С	3.95	4	4.05	0.156	0.157	0.159	
C1	0.35	0.4	0.45	0.014	0.016	0.018	
C2		1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°	
L1	0.63	0.64	0.65	0.025	0.025	0.026	
L2	1.2	1.3	1.4	0.047	0.051	0.055	
L3	3.415	3.42	3.425	0.134	0.135	0.135	
Η	0.24	0.25	0.26	0.009	0.010	0.010	



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
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